

PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1
Stylesheet Version v1.2

EPAS ID: PAT2853339


SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
HYUN YOUNG LEE	05/12/2014
RECEIVING PARTY DATA	
Name:	HYUN YOUNG LEE
Street Address:	(MUNJI-DONG)10-27, 339 EXPO-RO, YUSEONG-GU
City:	DAEJEON
State/Country:	KOREA, REPUBLIC OF
Postal Code:	305-380
Name:	RAYTRON CO., LTD
Street Address:	(MUNJI-DONG)10-27, 339 EXPO-RO, YUSEONG-GU
City:	DAEJEON
State/Country:	KOREA, REPUBLIC OF
Postal Code:	305-380
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	14276001
CORRESPONDENCE DATA	
Fax Number:	(703)935-8473
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ATTORNEY DOCKET NUMBER:	657-0004
NAME OF SUBMITTER:	DANIEL H. SHERR
SIGNATURE:	/Daniel H. Sherr/
DATE SIGNED:	05/13/2014
This document serves as an Oath/Declaration (37 CFR 1.63).	

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Total Attachments: 1

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DECLARATION (37 CFR 1.63) FOR UTILITY OR DESIGN APPLICATION USING AN APPLICATION DATA SHEET (37 CFR 1.76) AND ASSIGNMENT FOR MULTIPLE ASSIGNEES

Title of Invention	PHOTO SENSOR PACKAGE FOR LIGHTING
As the below named inventor, I hereby declare that:	
This declaration is directed to:	<input checked="" type="checkbox"/> The attached application, or <input type="checkbox"/> United States application or PCT international application number _____ filed on _____
The above-identified application was made or authorized to be made by me.	
I believe that I am the original inventor or an original joint inventor of a claimed invention in the application.	
WHEREAS,	
(1) LEE, Hyun Young residing at (Munji-dong)10-27, 339 Expo-ro, Yuseong-gu, Daejeon 305-380, Republic of Korea; and (2) Raytron Co., LTD with an office at (Munji-dong)10-27, 339 Expo-ro, Yuseong-gu, Daejeon 305-380, Republic of Korea	
respectively (hereinafter referred to as ASSIGNEES), are desirous of jointly acquiring all interest in, to and under said invention, said application disclosing the invention and in, to and under any Letters Patent or similar legal protection which may be granted therefor in the United States and in any and all foreign countries;	
NOW THEREFORE, in consideration of the sum of One Dollar (\$1.00), and other good and valuable consideration, the receipt and sufficiency of which are hereby acknowledged, I by these presents do hereby assign, sell and transfer unto said ASSIGNEES, their successors, assigns, and legal representatives, the entire right, title and interest in said invention, said application, including any divisions and continuations thereof, and in and to any and all Letters Patent of the United States, and countries foreign thereto, which may be granted for said invention, and in and to any and all priority rights and/or convention rights under the International Convention for the Protection of Industrial Property, Inter-American Convention Relating to Patents, Designs and Industrial Models, and any other international agreements to which the United States of America adheres, and to any other benefits accruing or to accrue to me with respect to the filing of applications for patents or securing of patents in the United States and countries foreign thereto, and I hereby authorize and request the Commissioner of Patents to issue said United States Letters Patent to said ASSIGNEES, as the assignees of the whole right, title and interest thereto;	
And I further agree to execute all necessary or desirable and lawful future documents, including assignments in favor of said ASSIGNEES or their designee(s), as ASSIGNEES or their successors, assigns and legal representatives may from time-to-time present to me and without further remuneration, in order to perfect title in said invention, modifications, and improvements in said invention, applications and Letters Patent of the United States and countries foreign thereto;	
And I further agree to properly execute and deliver and without further remuneration, such necessary or desirable and lawful papers for application for foreign patents, for filing subdivisions of said application for patent, and/or, for obtaining any reissue or reissues of any Letters patent which may be granted for my aforesaid invention, as said ASSIGNEES thereof shall hereafter require and prepare at their own expense;	
And I further agree that ASSIGNEES will, upon their request, be provided promptly with all pertinent facts and documents relating to said application, said invention and said Letters Patent and legal equivalents in foreign countries as may be known and accessible to me and will testify as to the same in any interference or litigation related thereto;	
And I hereby covenant that no assignment, sale, agreement or encumbrance has been or will be made or entered into which would conflict with this assignment and sale.	
I hereby acknowledge that any willful false statement made in this declaration is punishable under 18 U.S.C. 1001 by fine or imprisonment of not more than five (5) years, or both.	
LEGAL NAME OF INVENTOR	
Inventor: LEE, Hyun Young	Date: 12/05/2014
Signature: 	

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